

#### Welcome to E-XFL.COM

#### What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

E·XF

Product Status	Active
Core Processor	ARM® Cortex®-M0+
Core Size	32-Bit Single-Core
Speed	48MHz
Connectivity	CANbus, I <sup>2</sup> C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, WDT
Number of I/O	52
Program Memory Size	256КВ (256К х 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 20x12b, 3x16b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-VFQFN Exposed Pad
Supplier Device Package	64-QFN (9x9)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atsamc21j18a-mut

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

35.2.	Features	701
35.3.	Block Diagram	702
35.4.	Signal Description	
35.5.	Product Dependencies	703
35.6.	Functional Description	704
35.7.	Register Description	720
36. TCC	C – Timer/Counter for Control Applications	
36.1		773
36.2	Features	773
36.3	Riock Diagram	
36.4	Signal Description	
36.5	Broduct Description	
36.6	Functional Description	
36.7	Pogistor Summany	
36.8	Register Description	
50.0.		012
37. CCL	_ – Configurable Custom Logic	
37.1.	Overview	849
37.2.	Features	849
37.3.	Block Diagram	
37.4.	Signal Description	850
37.5.	Product Dependencies	
37.6.	Functional Description	852
37.7.	Register Summary	863
-		
37.8.	Register Description	
37.8. 38. ADC	Register Description C – Analog-to-Digital Converter	
37.8. 38. ADC 38.1.	Register Description C – Analog-to-Digital Converter Overview	
37.8. 38. ADC 38.1. 38.2.	Register Description C – Analog-to-Digital Converter Overview Features	
37.8. 38. ADC 38.1. 38.2. 38.3.	Register Description C – Analog-to-Digital Converter Overview Features Block Diagram.	
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4.	Register Description C – Analog-to-Digital Converter Overview Features Block Diagram Signal Description	
37.8. 38. ADC 38.1. 38.2. 38.3. 38.3. 38.4. 38.5.	Register Description C – Analog-to-Digital Converter Overview Features Block Diagram Signal Description Product Dependencies.	
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4. 38.4. 38.5. 38.6.	Register Description C – Analog-to-Digital Converter Overview Features Block Diagram Signal Description Product Dependencies Functional Description.	
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4. 38.5. 38.6. 38.7.	Register Description	
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4. 38.4. 38.5. 38.6. 38.6. 38.7. 38.8.	Register Description C – Analog-to-Digital Converter Overview Features Block Diagram Signal Description Product Dependencies Functional Description Register Summary Register Description	863 
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4. 38.5. 38.6. 38.7. 38.8. 38.8.	Register Description C – Analog-to-Digital Converter Overview Features Block Diagram Signal Description Product Dependencies Functional Description Register Summary Register Description	863 
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4. 38.5. 38.6. 38.7. 38.8. 39. SDA	Register Description	863 
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4. 38.5. 38.6. 38.7. 38.8. 39. SDA 39.1.	Register Description	863 867 867 867 869 869 869 869 871 886 887 906 906
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4. 38.5. 38.6. 38.7. 38.8. 39. SDA 39.1. 39.2. 20.2	Register Description.         C – Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         Product Dependencies.         Functional Description.         Register Summary.         Register Description.         ADC – Sigma-Delta Analog-to-Digital Converter.         Overview.         Features.	863 
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4. 38.5. 38.6. 38.7. 38.8. 39. SDA 39.1. 39.2. 39.3. 20.4	Register Description.         C – Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         Product Dependencies.         Functional Description.         Register Summary.         Register Description.         ADC – Sigma-Delta Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.	863 
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4. 38.5. 38.6. 38.7. 38.8. 39. SDA 39.1. 39.2. 39.3. 39.4. 20.5	Register Description.         C – Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         Product Dependencies.         Functional Description.         Register Summary.         Register Description.         ADC – Sigma-Delta Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.	863 
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4. 38.5. 38.6. 38.7. 38.8. 39. SDA 39.1. 39.2. 39.3. 39.4. 39.5.	Register Description	863 867 867 867 869 869 869 869 869 871 886 871 886 887 906 906 906 907 907
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4. 38.5. 38.6. 38.7. 38.8. 39. SDA 39.1. 39.2. 39.3. 39.4. 39.5. 39.6.	Register Description.         C – Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         Product Dependencies.         Functional Description.         Register Summary.         Register Description.         ADC – Sigma-Delta Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         Product Dependencies.         Functional Description.         NDC – Sigma-Delta Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         Product Dependencies.         Functional Description.         Product Dependencies.         Functional Description.	863 
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4. 38.5. 38.6. 38.7. 38.8. 39. SDA 39.1. 39.2. 39.3. 39.4. 39.5. 39.6. 39.7.	Register Description.         C – Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         Product Dependencies.         Functional Description.         Register Summary.         Register Description.         ADC – Sigma-Delta Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         Product Dependencies.         Functional Description.         Register Summary.         Register Description.         ADC – Sigma-Delta Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         Product Dependencies.         Functional Description.         Product Dependencies.         Functional Description.         Register Summary.	863 867 867 867 869 869 869 869 871 886 887 906 906 906 906 907 907 907 907
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4. 38.5. 38.6. 38.7. 38.8. 39. SDA 39.1. 39.2. 39.3. 39.4. 39.5. 39.6. 39.7. 39.8.	Register Description.         C - Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         Product Dependencies.         Functional Description.         Register Summary.         Register Description.         ADC - Sigma-Delta Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         Product Dependencies.         Functional Description.         ADC - Sigma-Delta Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         Product Dependencies.         Functional Description.         Product Dependencies.         Functional Description.         Register Summary.         Register Description.         Register Description.	863 
37.8. 38. ADC 38.1. 38.2. 38.3. 38.4. 38.5. 38.6. 38.7. 38.8. 39. SDA 39.1. 39.2. 39.3. 39.4. 39.5. 39.6. 39.7. 39.8. 40. AC -	Register Description.         C – Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         Product Dependencies.         Functional Description.         Register Summary.         Register Description.         ADC – Sigma-Delta Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         ADC – Sigma-Delta Analog-to-Digital Converter.         Overview.         Features.         Block Diagram.         Signal Description.         Product Dependencies.         Functional Description.         Product Dependencies.         Functional Description.         Register Summary.         Register Summary.         Register Description.         Register Description.         Register Description.	863 

arriving interrupts. Refer to Nested Vector Interrupt Controller and the Cortex-M0+ Technical Reference Manual for details (http://www.arm.com).

- System Timer (SysTick)
  - The System Timer is a 24-bit timer clocked by CLK\_CPU that extends the functionality of both the processor and the NVIC. Refer to the Cortex-M0+ Technical Reference Manual for details (http://www.arm.com).
- System Control Block (SCB)
  - The System Control Block provides system implementation information, and system control. This includes configuration, control, and reporting of the system exceptions. Refer to the Cortex-M0+ Devices Generic User Guide for details (http://www.arm.com).
- Micro Trace Buffer (MTB)
  - The CoreSight MTB-M0+ (MTB) provides a simple execution trace capability to the Cortex-M0+ processor. Refer to section Micro Trace Buffer and the CoreSight MTB-M0+ Technical Reference Manual for details (http://www.arm.com).
- Memory Protection Unit (MPU)
  - The Memory Protection Unit divides the memory map into a number of regions, and defines the location, size, access permissions and memory attributes of each region. Refer to the Cortex-M0+ Devices Generic User Guide for details (http://www.arm.com)

#### 10.1.3 Cortex-M0+ Address Map

#### Table 10-2. Cortex-M0+ Address Map

Address	Peripheral
0xE000E000	System Control Space (SCS)
0xE000E010	System Timer (SysTick)
0xE000E100	Nested Vectored Interrupt Controller (NVIC)
0xE000ED00	System Control Block (SCB)
0x41008000	Micro Trace Buffer (MTB)

#### **Related Links**

Product Mapping

#### 10.1.4 I/O Interface

#### 10.1.4.1 Overview

Because accesses to the AMBA<sup>®</sup> AHB-Lite<sup>™</sup> and the single cycle I/O interface can be made concurrently, the Cortex-M0+ processor can fetch the next instructions while accessing the I/Os. This enables single cycle I/O accesses to be sustained for as long as needed.

#### 10.1.4.2 Description

Direct access to PORT registers and DIVAS registers.

#### 14.6.2.5 Divide By Zero

A divide by zero fault occurs if the DIVISOR is programmed to zero. QUOTIENT will be zero and the REMAINDER is equal to DIVIDEND. Divide by zero sets the Divide-by-zero bit in the Status register (STATUS.DBZ) to one. STATUS.DBZ must be cleared by writing a one to it.

#### 14.6.2.6 Leading Zero Optimization

Leading zero optimization can reduce the time it takes to complete a division by skipping leading zeros in the DIVIDEND (or leading ones in signed mode). Leading zero optimization is enabled by default and can be disabled by the Disable Leading Zero bit in the Control A register (CTRLA.DLZ). When CTRLA.DLZ is zero, 16-bit division completes in 2-8 cycles and 32-bit division completes in 2-16 cycles, depending on the dividend value. If deterministic timing is required, setting CTRLA.DLZ to one forces 16-bit division to always take 8 cycles and 32-bit division to always take 16 cycles.

#### 14.6.2.7 Unsigned Square Root

When the square root input register (SQRNUM) is programmed, the square root function starts and the result will be stored in the Result and Remainder registers. The Busy status can be read from STATUS register.

also be entered when the CPU exits the lowest priority ISR. This mechanism can be useful for applications that only require the processor to run when an interrupt occurs. Before entering the IDLE mode, the user must configure the Sleep Configuration register.

 Exiting IDLE mode: The processor wakes the system up when it detects any non-masked interrupt with sufficient priority to cause exception entry. The system goes back to the ACTIVE mode. The CPU and affected modules are restarted.

Regulator operates in normal mode.

## STANDBY Mode

The STANDBY mode is the lowest power configuration while keeping the state of the logic and the content of the RAM.

In this mode, all clocks are stopped except those which are kept running if requested by a running peripheral or have the ONDEMAND bit written to "0". For example, the RTC can operate in STANDBY mode. In this case, its GCLK clock source will also be enabled.

All features that don't require CPU intervention are supported in STANDBY mode. Here are examples:

- Autonomous peripherals features.
- Features relying on Event System allowing autonomous communication between peripherals.
- Features relying on on-demand clock.
- DMA transfers.
- Entering STANDBY mode: This mode is entered by executing the WFI instruction with the SLEEPCFG register written to STANDBY. The SLEEPONEXIT feature is also available as in IDLE mode.
- Exiting STANDBY mode: Any peripheral able to generate an asynchronous interrupt can wake up the system. For example, a peripheral running on a GCLK clock can trigger an interrupt. When the enabled asynchronous wake-up event occurs and the system is woken up, the device will either execute the interrupt service routine or continue the normal program execution according to the Priority Mask Register (PRIMASK) configuration of the CPU.

Depending on the configuration of these modules, the current consumption of the device in STANDBY mode can be slightly different.

The regulator operates in low-power mode (LP VREG) by default and can switch automatically to the main regulator if a task required by a peripheral requires more power. It returns automatically in the low power mode as soon as the task is completed.

## 19.6.4 Advanced Features

## 19.6.4.1 RAM Automatic Low Power Mode

The RAM is by default put in low power mode (back-biased) if the device is in standby sleep mode.

This behavior can be changed by configuring the Back Bias bit in the Standby Configuration register (STDBYCFG.BBIASHS), refer to the table below for details.

**Note:** In standby sleep mode, the RAM is put in low-power mode by default. This means that the RAM is back-biased, and the DMAC cannot access it. The DMAC can only access the RAM when it is not back biased (PM.STDBYCFG.BBIASxx=0x0).

Bit	31	30	29	28	27	26	25	24
Access								
Reset								
Bit	23	22	21	20	19	18	17	16
Access								
Reset								
Bit	15	14	13	12	11	10	9	8
Access								
Reset								
Bit	7	6	5	4	3	2	1	0
						CLKFAIL	OSC32KRDY	XOSC32KRDY
Access						R/W	R/W	R/W
Reset						0	0	0

#### Bit 2 – CLKFAIL: XOSC32K Clock Failure Detection

This flag is cleared by writing a '1' to it.

This flag is set on a zero-to-one transition of the XOSC32K Clock Failure Detection bit in the Status register (STATUS.CLKFAIL) and will generate an interrupt request if INTENSET.CLKFAIL is '1'.

Writing a '0' to this bit has no effect.

Writing a '1' to this bit will clear the XOSC32K Clock Failure Detection flag.

#### Bit 1 – OSC32KRDY: OSC32K Ready

This flag is cleared by writing a '1' to it.

This flag is set by a zero-to-one transition of the OSC32K Ready bit in the Status register (STATUS.OSC32KRDY), and will generate an interrupt request if INTENSET.OSC32KRDY=1.

Writing a '0' to this bit has no effect.

Writing a '1' to this bit clears the OSC32K Ready interrupt flag.

#### Bit 0 – XOSC32KRDY: XOSC32K Ready

This flag is cleared by writing a '1' to it.

This flag is set by a zero-to-one transition of the XOSC32K Ready bit in the Status register (STATUS.XOSC32KRDY), and will generate an interrupt request if INTENSET.XOSC32KRDY=1.

Writing a '0' to this bit has no effect.

Writing a '1' to this bit clears the XOSC32K Ready interrupt flag.

## 21.8.4 Status

 Name:
 XOSC32K

 Offset:
 0x14 [ID-00001010]

 Reset:
 0x0000080

 Property:
 PAC Write-Protection

Bit	15	14	13	12	11	10	9	8
				WRTLOCK			STARTUP[2:0]	
Access				R/W		R/W	R/W	R/W
Reset				0		0	0	0
Bit	7	6	5	4	3	2	1	0
	ONDEMAND	RUNSTDBY		EN1K	EN32K	XTALEN	ENABLE	
Access	R/W	R/W		R/W	R/W	R/W	R/W	
Reset	1	0		0	0	0	0	

## Bit 12 – WRTLOCK: Write Lock

This bit locks the XOSC32K register for future writes, effectively freezing the XOSC32K configuration.

Value	Description
0	The XOSC32K configuration is not locked.
1	The XOSC32K configuration is locked.

## Bits 10:8 – STARTUP[2:0]: Oscillator Start-Up Time

These bits select the start-up time for the oscillator.

The OSCULP32K oscillator is used to clock the start-up counter.

 Table 21-3.
 Start-Up Time for 32KHz External Crystal Oscillator

STARTUP[2:0]	Number of OSCULP32K Clock Cycles	Number of XOSC32K Clock Cycles	Approximate Equivalent Time [ms]
0x0	1	3	0.122
0x1	32	3	1.068
0x2	2048	3	62.6
0x3	4096	3	125
0x4	16384	3	500
0x5	32768	3	1000
0x6	65536	3	2000
0x7	131072	3	4000

Note:

- 1. Actual Start-Up time is 1 OSCULP32K cycle + 3 XOSC32K cycles.
- 2. The given time assumes an XTAL frequency of 32.768kHz.

## 24. RTC – Real-Time Counter

## 24.1 Overview

The Real-Time Counter (RTC) is a 32-bit counter with a 10-bit programmable prescaler that typically runs continuously to keep track of time. The RTC can wake up the device from sleep modes using the alarm/ compare wake up, periodic wake up, or overflow wake up mechanisms.

The RTC can generate periodic peripheral events from outputs of the prescaler, as well as alarm/compare interrupts and peripheral events, which can trigger at any counter value. Additionally, the timer can trigger an overflow interrupt and peripheral event, and can be reset on the occurrence of an alarm/compare match. This allows periodic interrupts and peripheral events at very long and accurate intervals.

The 10-bit programmable prescaler can scale down the clock source. By this, a wide range of resolutions and time-out periods can be configured. With a 32.768kHz clock source, the minimum counter tick interval is  $30.5\mu$ s, and time-out periods can range up to 36 hours. For a counter tick interval of 1s, the maximum time-out period is more than 136 years.

## 24.2 Features

- 32-bit counter with 10-bit prescaler
- Multiple clock sources
- 32-bit or 16-bit counter mode
- One 32-bit or two 16-bit compare values
- Clock/Calendar mode
  - Time in seconds, minutes, and hours (12/24)
  - Date in day of month, month, and year
  - Leap year correction
- Digital prescaler correction/tuning for increased accuracy
- Overflow, alarm/compare match and prescaler interrupts and events
  - Optional clear on alarm/compare match

## 24.3 Block Diagram

Figure 24-1. RTC Block Diagram (Mode 0 — 32-Bit Counter)



Some registers require synchronization when read and/or written. Synchronization is denoted by the "Read-Synchronized" and/or "Write-Synchronized" property in each individual register description.

Optional write-protection by the Peripheral Access Controller (PAC) is denoted by the "PAC Write-Protection" property in each individual register description.

Some registers are enable-protected, meaning they can only be written when the module is disabled. Enable-protection is denoted by the "Enable-Protected" property in each individual register description.

#### 24.8.1 Control A in COUNT32 mode (CTRLA.MODE=0)

 Name:
 CTRLA

 Offset:
 0x00

 Reset:
 0x0000

 Property:
 PAC Write-Protection, Enable-Protected, Write-Synchronized

Bit	15	14	13	12	11	10	9	8
	COUNTSYNC					PRESCA	LER[3:0]	
Access	R/W				R/W	R/W	R/W	R/W
Reset	0				0	0	0	0
Bit	7	6	5	4	3	2	1	0
	MATCHCLR				MOD	E[1:0]	ENABLE	SWRST
Access	R/W			·	R/W	R/W	R/W	R/W
Reset	0				0	0	0	0

#### Bit 15 – COUNTSYNC: COUNT Read Synchronization Enable

The COUNT register requires synchronization when reading. Disabling the synchronization will prevent reading valid values from the COUNT register.

This bit is not enable-protected.

Value	Description
0	COUNT read synchronization is disabled
1	COUNT read synchronization is enabled

#### Bits 11:8 - PRESCALER[3:0]: Prescaler

These bits define the prescaling factor for the RTC clock source (GCLK\_RTC) to generate the counter clock (CLK\_RTC\_CNT). Periodic events and interrupts are not available when the prescaler is off. These bits are not synchronized.

Value	Name	Description
0x0	OFF	CLK_RTC_CNT = GCLK_RTC/1
0x1	DIV1	CLK_RTC_CNT = GCLK_RTC/1
0x2	DIV2	CLK_RTC_CNT = GCLK_RTC/2
0x3	DIV4	CLK_RTC_CNT = GCLK_RTC/4
0x4	DIV8	CLK_RTC_CNT = GCLK_RTC/8
0x5	DIV16	CLK_RTC_CNT = GCLK_RTC/16
0x6	DIV32	CLK_RTC_CNT = GCLK_RTC/32
0x7	DIV64	CLK_RTC_CNT = GCLK_RTC/64
0x8	DIV128	CLK_RTC_CNT = GCLK_RTC/128
0x9	DIV256	CLK_RTC_CNT = GCLK_RTC/256

Bit	31	30	29	28	27	26	25	24
Access								
Reset								
Bit	23	22	21	20	19	18	17	16
Access		•	•					
Reset								
Bit	15	14	13	12	11	10	9	8
					BUSYCHn	BUSYCHn	BUSYCHn	BUSYCHn
Access		•			R	R	R	R
Reset					0	0	0	0
Bit	7	6	5	4	3	2	1	0
	BUSYCHn							
Access	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

## Bits 11:0 – BUSYCHn: Busy Channel n [x=11..0]

This bit is cleared when the channel trigger action for DMA channel n is complete, when a bus error for DMA channel n is detected, or when DMA channel n is disabled.

This bit is set when DMA channel n starts a DMA transfer.

#### 25.8.13 Pending Channels

 Name:
 PENDCH

 Offset:
 0x2C

 Reset:
 0x0000000

 Property:

Value	Name	Description
0x36	TC5 MC0	TC5 Match/Compare 0 Trigger
0x37	TC5 MC1	TC5 Match/Compare 1 Trigger
0x38	TC6 OVF	TC6 Overflow Trigger
0x39	TC6 MC0	TC6 Match/Compare 0 Trigger
0x3A	TC6 MC1	TC6 Match/Compare 1 Trigger
0x3B	TC7 OVF	TC7 Overflow Trigger
0x3C	TC7 MC0	TC7 Match/Compare 0 Trigger
0x3D	TC7MC1	TC7 Match/Compare 1 Trigger

## Bits 6:5 – LVL[1:0]: Channel Arbitration Level

These bits define the arbitration level used for the DMA channel, where a high level has priority over a low level. For further details on arbitration schemes, refer to Arbitration.

These bits are not enable-protected.

TRIGACT[1:0]	Name	Description
0x0	LVL0	Channel Priority Level 0
0x1	LVL1	Channel Priority Level 1
0x2	LVL2	Channel Priority Level 2
0x3	LVL3	Channel Priority Level 3

## Bit 4 – EVOE: Channel Event Output Enable

This bit indicates if the Channel event generation is enabled. The event will be generated for every condition defined in the descriptor Event Output Selection (BTCTRL.EVOSEL).

This bit is available only for the least significant DMA channels. Refer to table: User Multiplexer Selection and Event Generator Selection of the Event System for details.

Value	Description
0	Channel event generation is disabled.
1	Channel event generation is enabled.

## Bit 3 – EVIE: Channel Event Input Enable

This bit is available only for the least significant DMA channels. Refer to table: *User Multiplexer Selection* and *Event Generator Selection* of the Event System for details.

Value	Description
0	Channel event action will not be executed on any incoming event.
1	Channel event action will be executed on any incoming event.

## Bits 2:0 – EVACT[2:0]: Event Input Action

These bits define the event input action, as shown below. The action is executed only if the corresponding EVIE bit in CHCTRLB register of the channel is set.

## Related Links

Physical Memory Map

## 27.6.6 Security Bit

The security bit allows the entire chip to be locked from external access for code security. The security bit can be written by a dedicated command, Set Security Bit (SSB). Once set, the only way to clear the security bit is through a debugger Chip Erase command. After issuing the SSB command, the PROGE error bit can be checked.

In order to increase the security level it is recommended to enable the internal BODVDD when the security bit is set.

## **Related Links**

DSU - Device Service Unit

## 27.6.7 Cache

The NVM Controller cache reduces the device power consumption and improves system performance when wait states are required. Only the NVM main array address space is cached. It is a direct-mapped cache that implements 8 lines of 64 bits (i.e., 64 Bytes). NVM Controller cache can be enabled by writing a '0' to the Cache Disable bit in the Control B register (CTRLB.CACHEDIS).

The cache can be configured to three different modes using the Read Mode bit group in the Control B register (CTRLB.READMODE).

The INVALL command can be issued using the Command bits in the Control A register to invalidate all cache lines (CTRLA.CMD=INVALL). Commands affecting NVM content automatically invalidate cache lines.

## 34.7 Register Summary

Offset	Name	Bit Pos.								
0x00		7:0								
0x01		15:8								
0x02	CREL	23:16		SUBST	[EP[3:0]					
0x03		31:24		REL	_[3:0]			STEI	<b>&gt;</b> [3:0]	
0x04		7:0				ETV	([7:0]			
0x05	ENDNI	15:8				ETV	[15:8]			
0x06	ENDN	23:16				ETV[	23:16]			
0x07		31:24				ETV[	31:24]			
0x08		7:0							DQO	S[1:0]
0x09	MRCEG	15:8								
0x0A		23:16								
0x0B		31:24								
0x0C		7:0		DTSE	G2[3:0]			DSJV	V[3:0]	
0x0D	DBTP	15:8						DTSEG1[4:0]		
0x0E		23:16	TDC					DBRP[4:0]		1
0x0F		31:24								
0x10		7:0	RX	ТХ	[1:0]	LBCK				
0x11	TEST	15:8								
0x12		23:16								
0x13		31:24								
0x14		7:0		WDC[7:0]						
0x15	RWD	15:8		WDV[7:0]						
0x16		23:16								
0x17		31:24								
0x18		7:0	TEST	DAR	MON	CSR	CSA	ASM	CCE	INIT
0x19	CCCR	15:8		TXP	EFBI	PXHD			BRSE	FDOE
0x1A		23:16								
0x1B		31:24								
0x1C		7:0					NTSEG2[6:0]			
0x1D	NBTP	15:8				NTSE	G1[7:0]			
0x1E		23:16				NBR	P[7:0]			
0x1F		31:24				NSJW[6:0]				NBRP[8:8]
0x20		7:0							TSS	S[1:0]
0x21	TSCC	15:8						TOP		
0x22		23:16						ICP	v[3:0]	
0x23		31:24				TOC				
0x24		/:0				ISC				
0x25	TSCV	32:40					150[14:8]			
0x26		23:16								
0x27		31:24						тоо	14.01	FTOO
0x28		/:U						105	o[1:0]	ETUC
0x29	тосс	15:8				тог	0[7:0]			
UX2A		23:16					۲[/:U]			
UX2B		31:24				TOP	[15:8]			

#### Bit 26 – WDIL: Watchdog Interrupt Line

Value	Description
0	Interrupt assigned to CAN interrupt line 0.
1	Interrupt assigned to CAN interrupt line 1.

## Bit 25 - BOL: Bus\_Off Status Interrupt Line

Value	Description
0	Interrupt assigned to CAN interrupt line 0.
1	Interrupt assigned to CAN interrupt line 1.

#### Bit 24 – EWL: Error Warning Status Interrupt Line

Value	Description
0	Interrupt assigned to CAN interrupt line 0.
1	Interrupt assigned to CAN interrupt line 1.

#### Bit 23 – EPL: Error Passive Interrupt Line

Value	Description
0	Interrupt assigned to CAN interrupt line 0.
1	Interrupt assigned to CAN interrupt line 1.

## Bit 22 – ELOL: Error Logging Overflow Interrupt Line

Value	Description
0	Interrupt assigned to CAN interrupt line 0.
1	Interrupt assigned to CAN interrupt line 1.

#### Bit 21 – BEUL: Bit Error Uncorrected Interrupt Line

Value	Description
0	Interrupt assigned to CAN interrupt line 0.
1	Interrupt assigned to CAN interrupt line 1.

#### Bit 20 – BECL: Bit Error Corrected Interrupt Line

Value	Description
0	Interrupt assigned to CAN interrupt line 0.
1	Interrupt assigned to CAN interrupt line 1.

#### Bit 19 – DRXL: Message stored to Dedicated Rx Buffer Interrupt Line

Value	Description
0	Interrupt assigned to CAN interrupt line 0.
1	Interrupt assigned to CAN interrupt line 1.

#### Bit 18 – TOOL: Timeout Occurred Interrupt Line

Value	Description
0	Interrupt assigned to CAN interrupt line 0.
1	Interrupt assigned to CAN interrupt line 1.

Bit	31	30	29	28	27	26	25	24
Access								
Reset								
Bit	23	22	21	20	19	18	17	16
Access								
Reset								
Bit	15	14	13	12	11	10	9	8
	RBSA[15:8]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
Bit	7	6	5	4	3	2	1	0
				RBS	<b>A</b> [7:0]			
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

## Bits 15:0 – RBSA[15:0]: Rx Buffer Start Address

Configures the start address of the Rx Buffers section in the Message RAM. Also used to reference debug message A,B,C. When the CAN module addresses the Message RAM it addresses 32-bit words, not single bytes. The configurable start addresses are 32-bit word addresses, i.e. only bits 15 to 2 are evaluated, the two least significant bits are ignored. Bits 1 to 0 will always be read back as "00".

## 34.8.31 Rx FIFO 1 Configuration

This register is write-restricted and only writable if bit fields CCCR.CCE = 1 and CCCR.INIT = 1.

Name:RXF1COffset:0xB0 [ID-0000a4bb]Reset:0x00000000Property:Write-restricted

Value	Description
0	The Match or Capture Channel x interrupt is disabled.
1	The Match or Capture Channel x interrupt is enabled.

#### Bit 1 – ERR: Error Interrupt Enable

Writing a '0' to this bit has no effect.

Writing a '1' to this bit will set the Error Interrupt Enable bit, which enables the Error interrupt.

Value	Description
0	The Error interrupt is disabled.
1	The Error interrupt is enabled.

#### Bit 0 – OVF: Overflow Interrupt Enable

Writing a '0' to this bit has no effect.

Writing a '1' to this bit will set the Overflow Interrupt Enable bit, which enables the Overflow interrupt request.

Value	Description
0	The Overflow interrupt is disabled.
1	The Overflow interrupt is enabled.

#### 35.7.2.7 Interrupt Flag Status and Clear

Name:	INTFLAG
Offset:	0x0A
Reset:	0x00
<b>Property:</b>	-

Bit	7	6	5	4	3	2	1	0
				MCx			ERR	OVF
Access				R/W			R/W	R/W
Reset				0			0	0

#### Bit 4 – MCx: Match or Capture Channel x

This flag is set on a comparison match, or when the corresponding CCx register contains a valid capture value. This flag is set on the next CLK\_TC\_CNT cycle, and will generate an interrupt request if the corresponding Match or Capture Channel x Interrupt Enable bit in the Interrupt Enable Set register (INTENSET.MCx) is '1'.

Writing a '0' to one of these bits has no effect.

Writing a '1' to one of these bits will clear the corresponding Match or Capture Channel x interrupt flag

In capture operation, this flag is automatically cleared when CCx register is read.

## Bit 1 – ERR: Error Interrupt Flag

This flag is set when a new capture occurs on a channel while the corresponding Match or Capture Channel x interrupt flag is set, in which case there is nowhere to store the new capture.

Writing a '0' to this bit has no effect.

Writing a '1' to this bit clears the Error interrupt flag.



Figure 36-27. Waveform Generation in RAMP2 mode with Restart Action

CaptureSeveral capture actions can be selected by writing the Fault n Capture Action bits in theActionFault n Control register (FCTRLn.CAPTURE). When one of the capture operations is<br/>selected, the counter value is captured when the fault occurs. These capture operations are<br/>available:

- CAPT the equivalent to a standard capture operation, for further details refer to Capture Operations
- CAPTMIN gets the minimum time stamped value: on each new local minimum captured value, an event or interrupt is issued.
- CAPTMAX gets the maximum time stamped value: on each new local maximum captured value, an event or interrupt (IT) is issued, see Figure 36-28.
- LOCMIN notifies by event or interrupt when a local minimum captured value is detected.
- LOCMAX notifies by event or interrupt when a local maximum captured value is detected.
- DERIV0 notifies by event or interrupt when a local extreme captured value is detected, see Figure 36-29.

#### CCx Content:

In CAPTMIN and CAPTMAX operations, CCx keeps the respective extremum captured values, see Figure 36-28. In LOCMIN, LOCMAX or DERIV0 operation, CCx follows the counter value at fault time, see Figure 36-29.

Before enabling CAPTMIN or CAPTMAX mode of capture, the user must initialize the corresponding CCx register value to a value different from zero (for CAPTMIN) top (for CAPTMAX). If the CCx register initial value is zero (for CAPTMIN) top (for CAPTMAX), no captures will be performed using the corresponding channel.

#### MCx Behaviour:

In LOCMIN and LOCMAX operation, capture is performed on each capture event. The MCx interrupt flag is set only when the captured value is upper or equal (for LOCMIN) or lower or equal (for LOCMAX) to the previous captured value. So interrupt flag is set when a new

Condition	Interrupt request	Event output	Event input	DMA request	DMA request is cleared
Capture Overflow Error	Yes				
Debug Fault State	Yes				
Recoverable Faults	Yes				
Non-Recoverable Faults	Yes				
TCCx Event 0 input			Yes <sup>(4)</sup>		
TCCx Event 1 input			Yes <sup>(5)</sup>		

Notes:

- 1. DMA request set on overflow, underflow or re-trigger conditions.
- 2. Can perform capture or generate recoverable fault on an event input.
- 3. In capture or circular modes.
- 4. On event input, either action can be executed:
  - re-trigger counter
  - control counter direction
  - stop the counter
  - decrement the counter
  - perform period and pulse width capture
  - generate non-recoverable fault
- 5. On event input, either action can be executed:
  - re-trigger counter
  - increment or decrement counter depending on direction
  - start the counter
  - increment or decrement counter based on direction
  - increment counter regardless of direction
  - generate non-recoverable fault

## 36.6.5.1 DMA Operation

The TCC can generate the following DMA requests:

Counter	If the Ones-shot Trigger mode in the control A register (CTRLA.DMAOS) is written to '0',
overflow (OVF)	the TCC generates a DMA request on each cycle when an update condition (overflow, underflow or re-trigger) is detected.
	When an update condition (overflow, underflow or re-trigger) is detected while
	CTRLA.DMAOS=1, the TCC generates a DMA trigger on the cycle following the DMA One-Shot Command written to the Control B register (CTRLBSET.CMD=DMAOS).
	In both cases, the request is cleared by hardware on DMA acknowledge.
Channel	A DMA request is set only on a compare match if CTRLA.DMAOS=0. The request is
Match (MCx)	cleared by hardware on DMA acknowledge.
	When CTRLA.DMAOS=1, the DMA requests are not generated.

## Figure 37-13. Edge Detector



## 37.6.2.7 Sequential Logic

Each LUT pair can be connected to the internal sequential logic which can be configured to work as D flip flop, JK flip flop, gated D-latch or RS-latch by writing the Sequential Selection bits on the corresponding Sequential Control x register (SEQCTRLx.SEQSEL). Before using sequential logic, the GCLK\_CCL clock and optionally each LUT filter or edge detector must be enabled.

**Note:** While configuring the sequential logic, the even LUT must be disabled. When configured the even LUT must be enabled.

## Gated D Flip-Flop (DFF)

When the DFF is selected, the D-input is driven by the even LUT output (LUT0 and LUT2), and the G-input is driven by the odd LUT output (LUT1 and LUT3), as shown in Figure 37-14.

## Figure 37-14. D Flip Flop



When the even LUT is disabled (LUTCTRL0.ENABLE=0 / LUTCTRL2.ENABLE=0), the flip-flop is asynchronously cleared. The reset command (R) is kept enabled for one APB clock cycle. In all other cases, the flip-flop output (OUT) is refreshed on rising edge of the GCLK\_CCL, as shown in Table 37-2.

R	G	D	Ουτ
1	Х	Х	Clear
0 1		1	Set
		0	Clear
	0	Х	Hold state (no change)

## JK Flip-Flop (JK)

When this configuration is selected, the J-input is driven by the even LUT output (LUT0 and LUT2), and the K-input is driven by the odd LUT output (LUT1 and LUT3), as shown in Figure 37-15.

Name:CTRLAOffset:0x00 [ID-00000bc7]Reset:0x00Property:PAC Write-Protection, Write-Synchronized



## Bit 6 – RUNSTDBY: Run in Standby

This bit is not synchronized

Value	Description
0	The DAC output buffer is disabled in standby sleep mode.
1	The DAC output buffer can be enabled in standby sleep mode.

## Bit 1 – ENABLE: Enable DAC Controller

Due to synchronization there is delay from writing CTRLA.ENABLE until the peripheral is enabled/ disabled. The value written to CTRLA.ENABLE will read back immediately and the corresponding bit in the Synchronization Busy register (SYNCBUSY.ENABLE) will be set. SYNCBUSY.ENABLE will be cleared when the operation is complete.

Value	Description
0	The peripheral is disabled or being disabled.
1	The peripheral is enabled or being enabled.

## Bit 0 – SWRST: Software Reset

Writing '0' to this bit has no effect.

Writing '1' to this bit resets all registers in the DAC to their initial state, and the DAC will be disabled.

Writing a '1' to CTRLA.SWRST will always take precedence, meaning that all other writes in the same write-operation will be discarded.

Due to synchronization there is a delay from writing CTRLA.SWRST until the reset is complete. CTRLA.SWRST and SYNCBUSY.SWRST will both be cleared when the reset is complete.

Value	Description
0	There is no reset operation ongoing.
1	The reset operation is ongoing.

## 41.8.2 Control B

Name:CTRLBOffset:0x01 [ID-00000bc7]Reset:0x00Property:PAC Write-Protection, Enable-Protected

Symbol	Parameters	Conditions (2)	Min	Тур	Max	Unit
ENOB	Effective Number Of Bits	Ext ref = 1.2V	13.5	14.2	14.4	dB
		Int Ref = 5.5V	11	11.2	11.4	
DR	Dynamic Range	Ext ref = 1.2V	89	91	92	dB
		Int Ref = 5.5V	83	92	96	
SNR	Signal to Noise Ratio	Ext ref = 1.2V	84	88	89	dB
		Int Ref = 5.5V	77	79	80	
SINAD	Signal to Noise + Distortion Ratio	Ext ref = 1.2V	83	87	89	dB
		Int Ref = 5.5V	68	69	71	
THD	Total Harmonic Distortion	Ext ref = 1.2V	-105	-100	-92	dB
		Int Ref = 5.5V	-70	-69	-69	

Table 45-24. SDADC AC Performance: : Differential Input Mode<sup>(1)</sup>

- 1. These are based on characterization.
- 2. OSR=256

## Table 45-25. Power consumption <sup>(1)</sup>

Symbol	Parameters	Conditions	Та	Тур.	Мах	Units
IDD VDDANA	Power consumption CTLSDADC=0x0 VCCANA = 5.5V SCLK_SDADC = CTLSDADC=0x0 VDDANA=Vref= 5 SCLK_SDADC =	CTLSDADC=0x0 External Ref - VCCANA = 5.5V Vref = 2V Ref buf on SCLK_SDADC = 6 MHz	Max 85°C Typ 25°C	588	658	μA
		CTLSDADC=0x0 Internal Ref - VDDANA=Vref= 5.5V Ref buf off SCLK_SDADC = 6 MHz		552	608	

1. These are based on characterization.

## 45.10.6 Digital to Analog Converter (DAC) Characteristics Table 45-26. Operating Conditions<sup>(1)</sup>

Symbol	Parameters	Conditions	Min	Тур	Мах	Unit
RES	Input resolution		-	-	10	Bits
VDDANA	Analog supply voltage		2.7	-	5.5	V
AVREF	External reference voltage		1	-	VDDANA - 0.6	V
	Internal reference voltage 1	VREF.SEL = 0x0	-	1.024	-	V
		VREF.SEL = 0x2	-	2.048	-	
		VREF.SEL = 0x3	-	4.096 (2)	-	
	Internal reference voltage 2		-	VDDANA	-	V
	Linear output voltage range		0.05	-	VDDANA - 0.05	V